Commercial Microelectronics Security Challenges

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together we advance_

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Challenges as Security Becomes Ubiquitous

Who is your Adversary?

- Question elicits a very interesting response
- Sophisticated Low-cost Attacks are on rise
  - Thermal Laser Stimulation[4] (TLS)
  - Electro-Optical Probing[5] (EOP)
- Emerging Sensing Capabilities
  - PLATYPUS[1], CPAmap[2], Sideline[3]

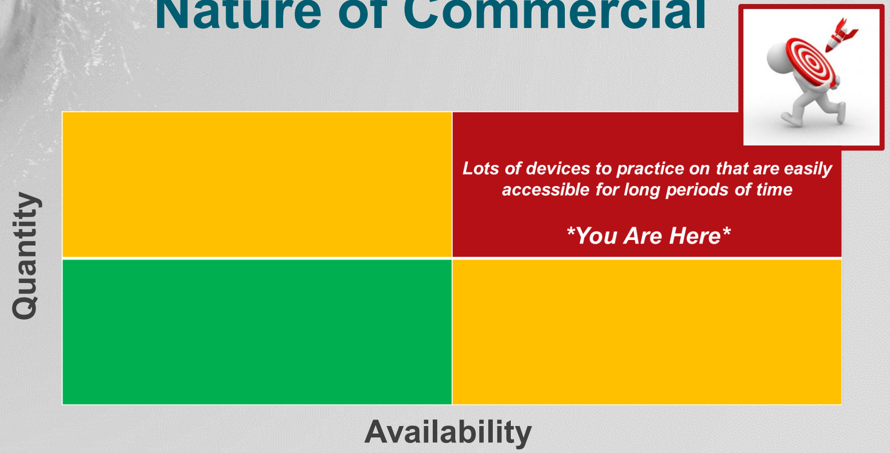
Emerging Requirements

- Multi-Tenancy
- Confidential Compute
- Close Physical Access
- Cost is Rising but how to monetize?

Multiple Standards

- NO Standards
- FIPS 140-3
- PCIe-IDE / TDISP
- Digital Cinema Initiative
- IEEE 802.11
- Payment Card Industry
- ISO21434
- IEC62443
- J3101 / J3201
- Open Compute Platform
- ISO / IEC 15408 Common Criteria
- Trusted Computing Group

Nature of Commercial


Lots of devices to practice on that are easily accessible for long periods of time
You Are Here
Quantity
Availability

Automotive

Communications

Defense

Data Center

Industrial, Vision and Healthcare

References

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